

# ISOLATED DC-DC CONVERTER CQB150-300S SERIES APPLICATION NOTE



## Approved By:

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	10.3 DC INPUT EMC Considerations	



### 1. Introduction

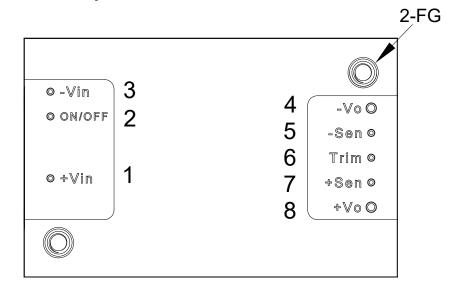
The CQB150-300S series of DC-DC converters offers 150 watts of output power @ single output voltages of 5, 12, 15, 24, 28, 48VDC with industry standard quarter-brick. It has a wide (2:1) input voltage range of 180 to 425VDC (300VDC nominal) and 3000VAC reinforced isolation.

Compliant with EN55032, EN45545. High efficiency up to 89%, allowing case operating temperature range of -40°C to 105°C (except M2 Series  $-55^{\circ}$ C to 105°C). An optional heat sink is available to extend the full power range of the unit. Very low no load power consumption (10mA), an ideal solution for energy critical systems.

The standard control functions include remote on/off (positive or negative) and +10%, -20% adjustable output voltage.

Fully protected against input UVLO (under voltage lock out), output over-current, output over-voltage and over-temperature and continuous short circuit conditions.

CQB150-300S series is highly suitable for distributed power architectures, telecommunications, servers, base station, battery operated equipment, and industrial applications.



### 2. Pin Function Description

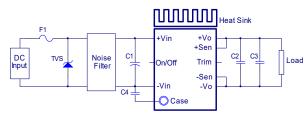
No	Label	Function	Description	Reference
1	+Vin	+V Input	Positive Supply Input	Section 7.1
2	ON/OFF	On/Off	External Remote On/Off Control	Section 6.5
3	-Vin	-V Input	Negative Supply Input	Section 7.1
4	-Vo	-V Output	Negative Power Output	Section 7.2/7.3
5	-Sen	-Sense	Negative Output Remote Sense	Section 6.6
6	Trim	Trim	External Output Voltage Adjustment	Section 6.7
7	+Sen	+Sense	Positive Output Remote Sense	Section 6.6
8	+Vo	+V Output	Positive Power Output	Section 7.2/7.3
		Mounting Insert	Mounting Insert (FG)	Section 9.5/10.2

Note: Base plate can be connected to FG through M3 threated mounting insert. Recommended torque 3Kgf-cm.



### 3. Connection for Standard Use

The connection for standard use is shown below. An external input capacitor (C1) 68uF for all models is recommended to reduce input ripple voltage. External output capacitors (C2, C3) and a Y capacitor (C4) are recommended to reduce output ripple and noise, 10uF aluminum and 1uF ceramic capacitor for 48Vout, and 10uF tantalum and 1uF ceramic capacitor for other models.



Symbol	Component	Reference	
F1, TVS	Input fuse, TVS	Section 10.1	
C1	External capacitor	Note 1	
	on input side	Section 7.2	
C2,C3	External capacitor	Section 7.2/7.3	
02,00	on the output side	00000117.277.5	
C4	External capacitor	Note 2	
04	on the case	Section 7.2	
Noise Filter	External input noise	Section 10.2	
	filter		
Remote On/Off	External Remote	Section 6.5	
	On/Off control		
Trim	External output	Section 6.7	
11000	voltage adjustment		
Heat sink	External heat sink	Section	
		9.2/9.3/9.4/9.5	
+Sense/-Sense		Section 6.6	

Note:

- 1. If the impedance of input line is high, C1 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.
- 2. Disc ceramic capacitor 1500pF (type KX Class X1 Y1 series Murata).

## 4. Test Set-Up

The basic test set-up to measure parameters such as efficiency and load regulation is shown below. When testing the modules under any transient conditions please ensure that the transient response of the source is sufficient to power the equipment under test. We can calculate:

- Efficiency
- Load regulation and line regulation

The value of efficiency is defined as:

$$\eta = \frac{V_o \times I_o}{V_{in} \times I_{in}} \times 100\%$$

Where:

 $V_o$  is output voltage  $I_o$  is output current  $V_{in}$  is input voltage  $I_{in}$  is input current

The value of load regulation is defined as:

Load reg. = 
$$\frac{V_{FL} - V_{NL}}{V_{NL}} \times 100\%$$

Where:

 $V_{\text{FL}}$  is the output voltage at full load.

 $V_{\text{NL}}$  is the output voltage at no load.

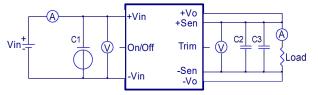
The value of line regulation is defined as:

Line reg. = 
$$\frac{V_{HL} - V_{LL}}{V_{LL}} \times 100\%$$

Where:

 $V_{\text{HL}}$  is the output voltage of maximum input voltage at full load.

 $V_{\text{LL}}$  is the output voltage of minimum input voltage at full load.



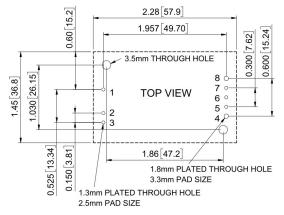
CQB150-300S Series Test Setup

- C1: 68uF/450V ESR<0.7Ω
- C2: 1uF/1210 ceramic capacitor
- C3: 10uF aluminum capacitor for 48Vout. 10uF tantalum capacitor for others.

### 5. Recommend Layout, PCB Footprint and Soldering Information

The system designer or end user must ensure that metal and other components in the vicinity of the converter meet the spacing requirements for which the system is approved. Low resistance and inductance PCB layout traces are the norm and should be used where possible. Due consideration must also be given to proper low impedance tracks between power module, input and output grounds.

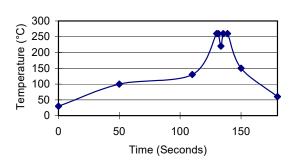




Clean the soldered side of the module with a brush, prevent liquid from getting into the module. Do not clean by soaking the module into liquid. Do not allow solvent to come in contact with product labels or resin case as this may changed the color of the resin case or cause deletion of the letters printed on the product label. After cleaning, dry the modules well.

The suggested soldering iron is  $450^{\circ}$ C for up to 5seconds (less than 50W). Furthermore, the recommended soldering profile is shown below, and PCB layout is referring to **Section 10.2**.

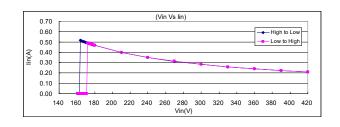
Lead Free Wave Soldering Profile



## 6. Features and Functions

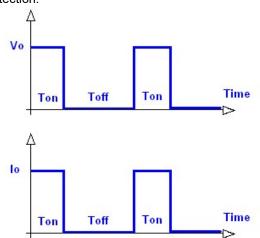
### 6.1 UVLO (Under Voltage Lock Out)

Input under voltage lockout is standard on the CQB150-300S series unit. The unit will shut down when the input voltage drops below a threshold, and the unit will operate when the input voltage goes above the upper threshold.



### 6.2 Over Current / Short Circuit Protection

All models have internal over current and continuous short circuit protection. The unit operates normally once the fault condition is removed. At the point of current limit inception, the converter will go into hiccup mode protection.



### 6.3 Output Over Voltage Protection

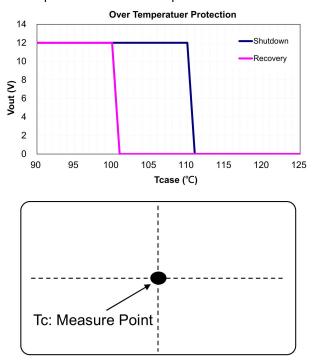
The output over voltage protection consists of circuitry that internally limits the output voltage. If more accurate output over voltage protection is required, then an external circuit can be used via the remote on/off pin.

**Note**: Please note that device inside the power supply might fail when voltage more than rate output voltage is applied to output pin. This could happen when the customer tests the over voltage protection of unit.



### 6.4 Over Temperature Protection

These modules have an over temperature protection circuit to safeguard against thermal damage. Shutdown occurs with the maximum case reference temperature is exceeded. The module will restart when the case temperature falls below over temperature recovery threshold. Please measure case temperature of the center part of aluminum base plate.



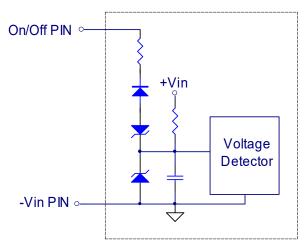
6.5 Remote On/Off

The CQB150-300S series allows the user to switch the module on and off electronically with the remote On/Off feature. All models are available in "positive logic" and "negative logic" (optional) versions. The converter turns on if the remote On/Off pin is high (>3.5Vdc to 75Vdc or open circuit). Setting the pin low (0 to<1.2Vdc, except M2 Series is 0 to<1.0Vdc) will turn the converter off. The signal level of the remote On/Off input is defined with respect to ground. If not using the remote On/Off pin, leave the pin open (converter will be on).

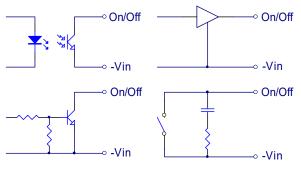
Models with part number suffix "N" are the "negative logic" remote On/Off version. The unit turns off if the remote On/Off pin is high (>3.5Vdc to 75Vdc or open circuit). The converter turns on if the On/Off pin input is low (0 to<1.2Vdc, except M2 Series is 0 to<1.0Vdc). Note that the converter is off by default.

Logic State (Pin 2)	Negative Logic	Positive Logic
Logic Low	Module on	Module off
Logic High	Module off	Module on

The converter remote On/Off circuit built-in on input side. The ground pin of input side Remote On/Off circuit is -Vin pin. Inside connection sees below.



Connection examples see below.



Remote On/Off Connection Example

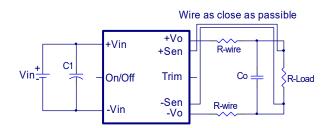
### 6.6 Output Remote Sensing

The CQB150-300S series converter has the capability to remotely sense both lines of its output. This feature moves the effective output voltage regulation point from the output of the unit to the point of connection of the remote sense pins. This feature automatically adjusts the real output voltage of the CQB150-300S series in order to compensate for voltage drops in distribution and maintain a regulated voltage at the point of load. The remote-sense voltage range is:

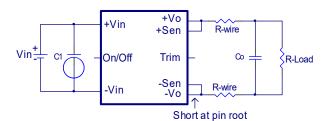
$$[(+V_{out}) - (-V_{out})] - [(+Sense) - (-Sense)] \le 10\%$$
 of Vo nominal

When remote sense is in use, the sense should be connected by twisted-pair wire or shield wire. If the sensing patterns short, heave current flows and the pattern may be damaged. Output voltage might become unstable because of impedance of wiring and load condition when length of wire is exceeding 400mm. This is shown in the schematic below.





If the remote sense feature is not to be used, the sense pins should be connected locally. The +Sense pin should be connected to the +Vout pin at the module and the -Sense pin should be connected to the -Vout pin at the module. Wire between +Sense and +Vout and between -Sense and -Vout as short as possible. Loop wiring should be avoided. The converter might become unstable by noise coming from poor wiring. This is shown in the schematic below.

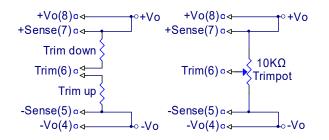


#### Note:

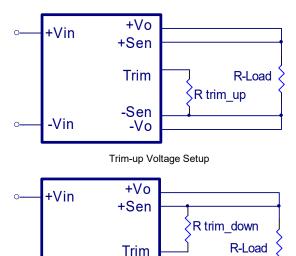
Although the output voltage can be varied (increased or decreased) by both remote sense and trim, the maximum variation for the output voltage is the larger of the two values not the sum of the values. The output power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. Using remote sense and trim can cause the output voltage to increase and consequently increase the power output of the module if output current remains unchanged. Always ensure that the output power of the module remains at or below the maximum rated power. Also be aware that if  $V_{o.set}$  is below nominal value,  $P_{out.max}$  will also decrease accordingly because  $I_{o.max}$  is an absolute limit. Thus,  $P_{out.max} = V_{o.set} \times I_{o.max}$  is also an absolute limit.

#### 6.7 Output Voltage Adjustment

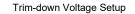
Output may be externally trimmed (-20% to +10%) with a fixed resistor or an external trim pot as shown (optional). Model specific formulas for calculating trim resistors are available upon request as a separate document.



In order to trim the voltage up or down, one needs to connect the trim resistor either between the trim pin and -Sense for trim-up or between trim pin and +Sense for trim-down. The output voltage trim range is -20% to +10%. This is shown:







-Sen

The value of R<sub>trim up</sub> defined as:

-Vin

For Vo=5V Rtrim\_up decision:

$$R_{trim\_up} = \frac{R_1 V_r}{Vo - Vo\_nom} - R_2 \quad (K\Omega)$$

For others Rtrim\_up decision:

$$R_{trim\_up} = \left(\frac{R_1(V_r - V_f(\frac{R_2}{R_2 + R_3}))}{V_o - V_o\_nom}\right) - \frac{R_2R_3}{R_2 + R_3}$$
(KΩ)

Where:

 $R_{trim up}$  is the external resistor in K $\Omega$ .

Vo, nom is the nominal output voltage.

Vo is the desired output voltage.

R1, R2, R3, Vf and Vr are internal to the unit and are defined in Table 1.



Model Number	Output	R1	R2	R3	Vr	Vf
	Voltage(V)	(ΚΩ)	(ΚΩ)	(ΚΩ)	(V)	(V)
CQB150-300S05	5.0	2.32	1.8	0	2.5	0
CQB150-300S12	12.0	9.1	24	5.1	2.5	0.5
CQB150-300S15	15.0	12	36	8.25	2.5	0.5
CQB150-300S24	24.0	20	68	7.5	2.5	0.5
CQB150-300S28	28.0	23.7	68	6.2	2.5	0.5
CQB150-300S48	48.0	36	82	5.1	2.5	0.5

For example, to trim-up the output voltage of 12V module (CQB150-300S12) by 5% to 12.6V,  $R_{trim_up}$  is calculated as follows:

$$R_{trim\_up} = \frac{18.997}{0.6} - 4.206 = 27.45 \, (\text{K}\Omega)$$

#### The typical value of $R_{\text{trim\_up}}$

Trim	5.0V	12V	15V	24V	28V	48V	
up (%)		R <sub>trim_up</sub> (KΩ)					
1%	114.2	154.1	160.7	164.0	167.1	147.3	
2%	56.20	74.95	77.01	78.64	80.72	71.29	
3%	36.86	48.56	49.10	50.18	51.92	45.93	
4%	27.20	35.37	35.15	35.94	37.52	33.24	
5%	21.40	27.45	26.78	27.40	28.88	25.63	
6%	17.53	22.17	21.19	21.71	23.12	20.56	
7%	14.77	18.41	17.21	17.64	19.00	16.94	
8%	12.70	15.58	14.22	14.59	15.92	14.22	
9%	11.08	13.38	11.89	12.22	13.52	12.10	
10%	9.800	11.62	10.03	10.32	11.60	10.41	

The value of R<sub>trim\_down</sub> defined as:

$$R_{trim\_down} = \frac{R_1 \times (V_o - V_r)}{V_o \quad nom - V_o} - R_2$$
(KΩ)

Where:

 $R_{trim\_down}$  is the external resistor in K $\Omega$ .

 $V_{\text{o, nom}}$  is the nominal output voltage.

 $V_{\text{o}}$  is the desired output voltage.

R1, R2, R3 and Vr are internal to the unit and are defined in Table 1.

For example: to trim-down the output voltage of 12V module (CQB150-300S12) by 5% to 11.4V,  $R_{trim\_down}$  is calculated as follows:

$$V_{o\_nom} - V_o = 12 - 11.4 = 0.6 V \\ R1 = 9.1 K\Omega, R2 = 24 K\Omega, V_r = 2.5 V$$

$$R_{trim} \,_{down} = \frac{9.1 \times (11.4 - 2.5)}{0.6} - 24 = 110.98 \ (K\Omega)$$

The typical value of R<sub>trim\_down</sub>

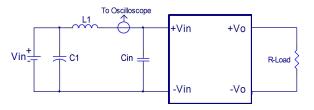
Trim	5.0V	12V	15V	24V	28V	48V	
down (%)	R <sub>trim_down</sub> (KΩ)						
1%	111.8	687.3	952.0	1703	2066	3294	
2%	53.88	327.1	452.0	807.8	987.4	1588	
3%	34.55	207.0	285.3	509.2	627.7	1019	
4%	24.88	147.0	202.0	359.9	447.8	735.1	
5%	19.08	110.9	152.0	270.3	339.9	564.5	
6%	15.21	86.96	118.6	210.6	268.0	450.7	
7%	12.45	69.81	94.85	167.9	216.6	369.5	
8%	10.38	56.95	77.00	135.9	178.0	308.5	
9%	8.769	46.94	63.11	111.0	148.1	261.1	
10%	7.480	38.94	52.00	91.16	124.1	223.2	
11%	6.425	32.39	42.90	74.87	104.5	192.2	
12%	5.547	26.93	35.33	61.30	88.16	166.3	
13%	4.803	22.31	28.92	49.82	74.33	144.5	
14%	4.166	18.35	23.42	39.97	62.47	125.7	
15%	3.613	14.92	18.66	31.44	52.19	109.5	
16%	3.130	11.92	14.50	23.97	43.20	95.28	
17%	2.704	9.277	10.82	17.39	35.26	82.73	
18%	2.324	6.923	7.556	11.53	28.21	71.58	
19%	1.985	4.817	4.632	6.298	21.90	61.60	
20%	1.680	2.921	2.000	1.583	16.22	52.62	



## 7. Input / Output Considerations

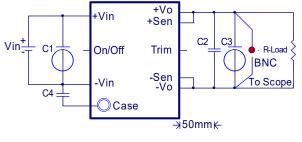
### 7.1 Input Capacitance at the Power Module

The converters must be connected to low AC source impedance. To avoid problems with loop stability source inductance should be low. Also, the input capacitors (Cin) should be placed close to the converter input pins to de-couple distribution inductance. However, the external input capacitors are chosen for suitable ripple handling capability. Low ESR capacitors are good choice. Circuit as shown as below represents typical measurement methods for reflected ripple current. C1 and L1 simulate a typical DC source impedance. The input reflected-ripple current is measured by current probe to oscilloscope with a simulated source Inductance (L1).



L1: 12uH C1:330uF ESR<0.7ohm @100KHz Cin:180uF ESR<0.7ohm @100KHz

### 7.2 Output Ripple and Noise



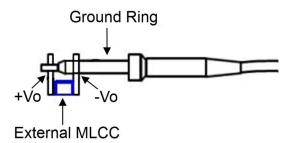
Output ripple and noise

- C2: 1uF/1210 ceramic capacitor
- C3: 10uF aluminum solid capacitor
- C4: Disc ceramic capacitor 1500pF

Output ripple and noise measured with 10uF aluminum and 1uF ceramic capacitor across output for 48Vout and with 10uF tantalum and 1uF ceramic capacitor for others. A 20 MHz bandwidth oscilloscope is normally used for the measurement. The conventional ground clip on an oscilloscope probe should never be used in this kind of measurement. This clip, when placed in a field of radiated high frequency energy, acts as an antenna or inductive pickup loop, creating an extraneous voltage that is not part of the output noise of the converter.



Another method is shown in below, in case of coaxialcable/BNC is not available. The noise pickup is eliminated by pressing scope probe ground ring directly against the -Vout terminal while the tip contacts the +Vout terminal. This makes the shortest possible connection across the output terminals.





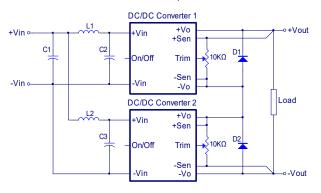
#### 7.3 Output Capacitance

The CQB150-300S series converters provide unconditional stability with or without external capacitors. For good transient response, low ESR output capacitors should be located close to the point of load (<100mm). PCB design emphasizes low resistance and inductance tracks in consideration of high current applications. Output capacitors with their associated ESR values have an impact on loop stability and bandwidth. Cincon's converters are designed to work with load capacitance to see specifications.

## 8. Series and Parallel Operation

### 8.1 Series Operation

Series operation is possible by connecting the outputs two or more units. Connection is shown in below. The output current in series connection should be lower than the lowest rate current in each power module.



#### **Simple Series Operation Connect Circuit**

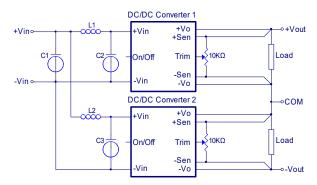
L1, L2: 1.0uH

C1, C2, C3: 68uF/450V ESR<0.7Ω

#### Note:

- 1. If the impedance of input line is high, C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.
- 2. Recommend Schottky diode(D1, D2) be connected across the output of each series connected converter, so that if one converter shuts down for any reason, then the output stage won't be thermally overstressed. Without this external diode, the output stage of the shut-down converter could carry the load current provided by the other series converters, with its MOSFETs conducting through the body diodes. The MOSFETs could then be overstressed and fail. The external diode should be capable of handling the full load current for as long as the application is expected to run with any unit shut down.

Series for  $\pm$ output operation is possible by connecting the outputs two units, as shown in the schematic below.



#### Simple ±Output Operation Connect Circuit

L1, L2: 1.0uH C1, C2, C3: 68uF/450V ESR<0.7Ω

#### Note:

If the impedance of input line is high, C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.

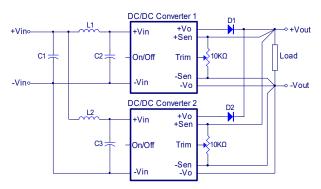
### 8.2 Parallel Operation

The CQB150-300S series parallel operation is not possible



### 8.3 Redundant Operation

Parallel for redundancy operation is possible by connecting the units as shown in the schematic below. The current of each converter become unbalance by a slight difference of the output voltage. Make sure that the output voltage of units of equal value and the output current from each power supply does not exceed the rate current. Suggest use an external potentiometer to adjust output voltage from each power supply.



#### Simple Redundant Operation Connect Circuit

L1, L2: 1.0uH

C1, C2, C3: 68uF/450V ESR<0.7Ω

#### Note:

If the impedance of input line is high10., C1, C2, C3 capacitance must be more than above. Use more than two recommended capacitor above in parallel when ambient temperature becomes lower than -20°C.



## 9. Thermal Design

### 9.1 Operating Temperature Range

The CQB150-300S series converters can be operated within a wide case temperature range of -40°C to 105°C. Consideration must be given to the derating curves when ascertaining maximum power that can be drawn from the converter. The maximum power drawn from open quarter brick models is influenced by usual factors, such as:

- Input voltage range
- Output load current
- Forced air or natural convection
- Heat sink optional

### 9.2 Convection Requirements for Cooling

To predict the approximate cooling needed for the quarter brick module, refer to the power derating curves in **section 9.4**. These derating curves are approximations of the ambient temperatures and airflows required to keep the power module temperature below its maximum rating. Once the module is assembled in the actual system, the module's temperature should be monitored to ensure it does not exceed 105°C as measured at the center of the top of the case (thus verifying proper cooling).

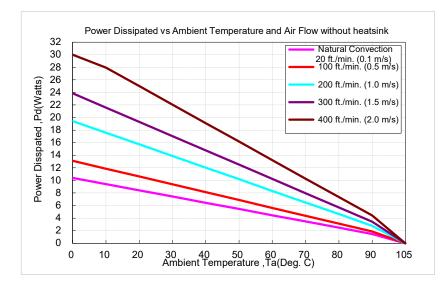
#### 9.3 Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. The example is presented in **section 9.4**. The power output of the module should not be allowed to exceed rated power ( $V_{o_{set}} \times I_{o_{max}}$ ).

### 9.4 Power Derating

The operating case temperature range of CQB150-300S series is  $-40^{\circ}$ C to  $+105^{\circ}$ C. When operating the CQB150-300S series, proper derating or cooling is needed. The maximum case temperature under any operating condition should not exceed  $105^{\circ}$ C.

The following curve is the de-rating curve of CQB150-300S series without heat sink.



AIR FLOW RATE	TYPICAL R <sub>ca</sub>
Natural Convection 20ft./min. (0.1m/s)	10.1 °C/W
100 ft./min. (0.5m/s)	8.0 °C/W
200 ft./min. (1.0m/s)	5.4 °C/W
300 ft./min. (1.5m/s)	4.4 °C/W
400 ft./min. (2.0m/s)	3.4 °C/W



#### Example:

What is the minimum airflow necessary for a CQB150-300S12 operating at nominal line voltage, an output current of 12.5A, and a maximum ambient temperature of 40°C?

#### Solution:

**Given:** V<sub>in</sub>= 300V<sub>dc</sub>, Vo= 12V<sub>dc</sub>, I<sub>o</sub>= 12.5A

**Determine Power dissipation (P**<sub>d</sub>):  $P_d = P_i - P_o = P_o(1-\eta)/\eta$ ,  $P_d = 12V \times 12.5A \times (1-0.89)/0.89 = 18.54$  Watts

Determine airflow: Given: P<sub>d</sub>= 18.54W and T<sub>a</sub>= 40°C

Check Power Derating curve: Minimum airflow= 400 ft./min.

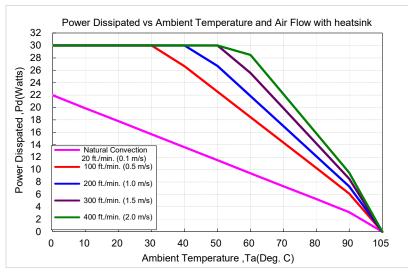
Verify:

Maximum temperature rise is ∆T= Pd × Rca = 18.54W×3.4=63.04°C

Maximum case temperature is  $T_c = T_a + \Delta T = 103.04^{\circ}C < 105^{\circ}C$ 

#### Where:

The  $R_{ca}$  is thermal resistance from case to ambient environment. T<sub>a</sub> is ambient temperature and T<sub>c</sub> is case temperature.



AIR FLOW RATE	TYPICAL R <sub>ca</sub>
Natural Convection 20ft./min. (0.1m/s)	4.78 °C/W
100 ft./min. (0.5m/s)	2.44 °C/W
200 ft./min. (1.0m/s)	2.06 °C/W
300 ft./min. (1.5m/s)	1.76 °C/W
400 ft./min. (2.0m/s)	1.58 °C/W

#### Example with heat sink QBT210 (M-C421):

What is the minimum airflow necessary for a CQB150-300S12 operating at nominal line voltage, an output current of 12.5A, and a maximum ambient temperature of  $40^{\circ}$ C?

Solution:

Given: Vin= 300Vdc, Vo= 12Vdc, Io= 12.5A

**Determine Power dissipation (P<sub>d</sub>):**  $P_d = P_i - P_o = P_o(1-\eta)/\eta$ ,  $Pd = 5.0 \times 30 \times (1-0.89)/0.89 = 18.54$  Watts

**Determine airflow:** Given:  $P_d$ = 18.54W and  $T_a$  = 40°C

Check above Power de-rating curve: Minimum airflow= 100 ft./min

Verify:

Maximum temperature rise is  $\Delta T = P_d \times R_{ca} = 18.54 \times 2.44 = 45.24^{\circ}C$ Maximum case temperature is  $T_c = T_a + \Delta T = 85.24^{\circ}C < 105^{\circ}C$ 

Where:

The  $R_{\mbox{\scriptsize ca}}$  is thermal resistance from case to ambient environment.

 $T_{a}\xspace$  is ambient temperature and  $T_{c}\xspace$  is case temperature.



4-<u>ø3.3</u>

σ Æ

ω

2.54

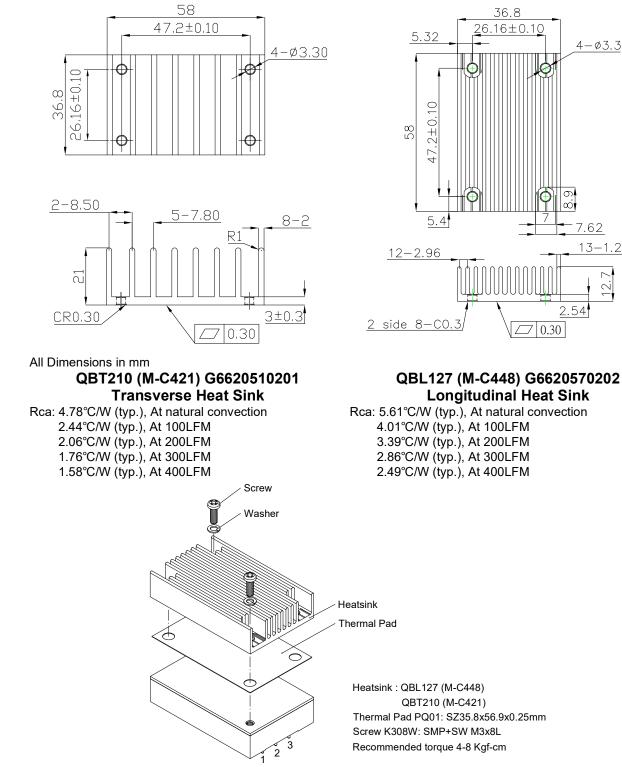
7 0.30

7.62

13-1.27

12.

### 9.5 Quarter Brick Heat Sinks

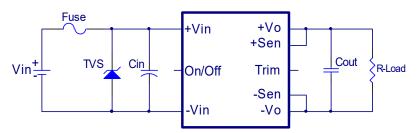




## 10. Safety & EMC

### 10.1 Input Fusing and Safety Considerations

The CQB150-300S series converters have no internal fuse. In order to achieve maximum safety and system protection, always use an input line fuse. We recommended a 2A time delay fuse for all models. It is recommended that the circuit have a transient voltage suppressor diode (TVS) across the input terminal to protect the unit against surge or spike voltage and input reverse voltage (as shown).



The external input capacitor (Cin) and transient voltage suppressor diode (TVS) are required if CQB150-300S series has to meet EN61000-4-4, EN61000-4-5.

The Cin recommended a 68uF/450V aluminum capacitor. And the TVS recommended a SMCJ440A transient voltage suppressor.

### 10.2 AC INPUT EMC Considerations

EMI Test standard: EN55032 Class A

Test Condition: Input Voltage: 220Vac, Output Load: Full Load

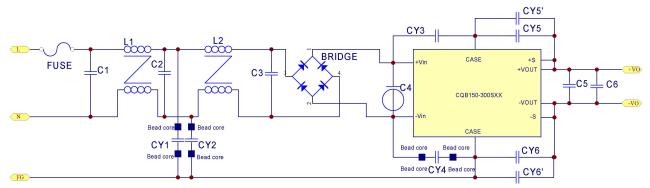


Figure1 Connection circuit

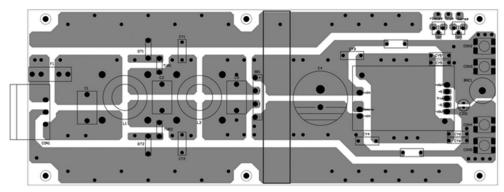


Figure2 PCB layout top view



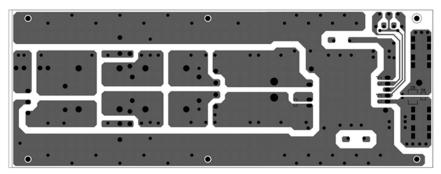


Figure3 PCB layout bottom view

### Components value:

			Mode	l Number				
	CQB150-300S05	CQB150-300S12	CQB150-300S1	5 CQB150-300S24	CQB150-300S28	CQB150-300S48		
C1			0.68	uF/305V				
C2				2 Cap.				
C3	]		MKP	62(C42)				
C4	68uF/450V Aluminum Cap. KXG series							
C5				50V X7R 220		4.7uF/100V X7R 2220		
C6						1uF/100V X7R 1210		
L1 L2	-	5.5mH /5A	BULL WILL UR	T24-050055H (G91	C7221622)			
BRIDGE				BU80-C 0V 10A				
CY1			10	)00pF				
CY2			10	)00pF				
CY3	1500pF							
CY4			15	500pF				
CY5, CY5'	4700pF							
CY6, CY6'			47	'00pF				

Note:

1. CY1, CY2, CY4 Bead Core: A6B T 4\*1.5\*2 KING CORE (or BRI 4.0\*1.5\*2.0mm CHILISIN) or equivalent. 2. CY1 to CY6 as above all Capacitors: Type CD Series TDK



### EN55032 Class A Conducted Emission CONDUCTION

**※**Test with Metal Plate Connect to Case and Earth.

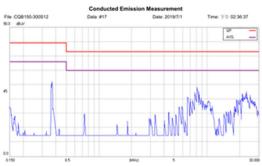
Test Standard: EN55032/55022 Class A Conducted Emission Conduction

CQB150-300S05 Line

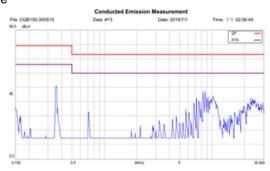


### CQB150-300S12

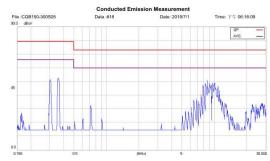
Line



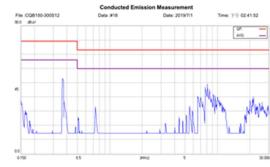
#### CQB150-300S15 Line



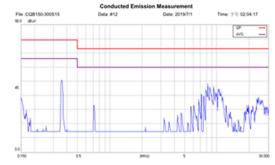
#### Neutral



Neutral

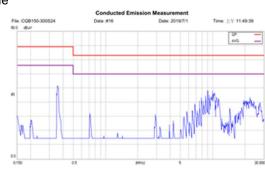


Neutral



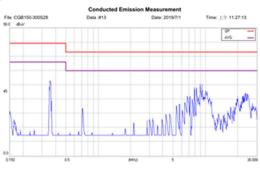


CQB150-300S24 Line

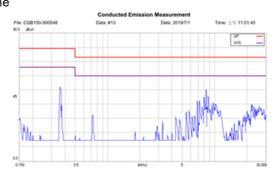


CQB150-300S28



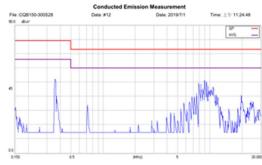


CQB150-300S48 Line

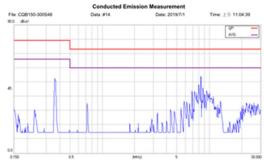


Neutral

Neutral





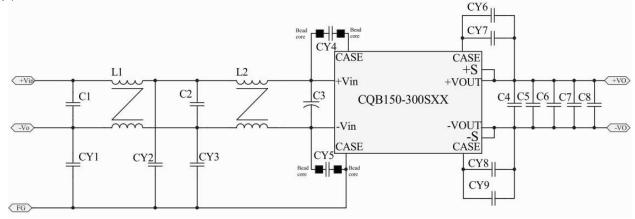




### 10.3 DC INPUT EMC Considerations

EMI Test standard: EN55022/EN55032 Class A Conducted Emission Test Condition: Input Voltage: 300VDC, Output Load: Full Load

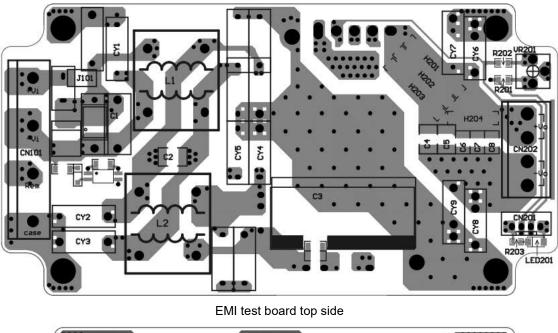
(1) EMI and conducted noise meet EN55032 Class A:

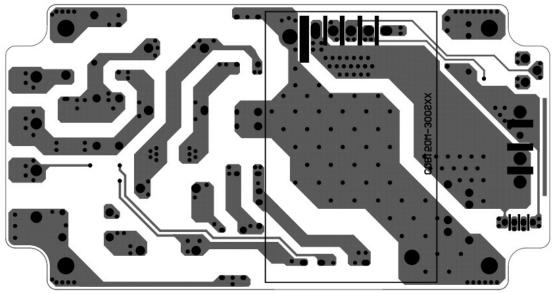


#### Figure4 Connection circuit for conducted EMI Class A testing

Part Number	Value
C1	0.47uF/520V Polyester Film Capacitor MPN2 Type HJC
C2	0.1uF/630V 1812 X7R
C3	33uF/450V Aluminum Capacitor KXJ Series Nippon Chemi-Con
C4,C5	4.7uF/100V X7R 1812
C6,C7,C8	0.47uF/250V X7R 1210
CY1, CY2	100pF CD Type Y1 CAP TDK
CY3	1000pF CD Type Y1 CAP TDK
CY4, CY5	1500pF CD Type Y1 CAP TDK
CY6, CY7, CY8, CY9	4700pF CD Type Y1 CAP TDK
L1, L2	5mH 0.25*1.0mm/34T YAXIN (G91C7523423)
CY4, CY5 Bead Core	SN30 T2.8*1.7*2 SM



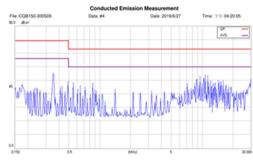




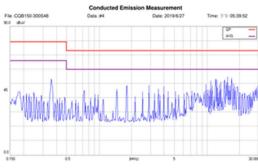
EMI test board bottom side



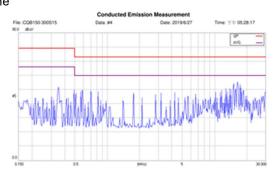
CQB150-300S05 Line



CQB150-300S12 Line

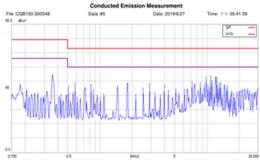


CQB150-300S15 Line

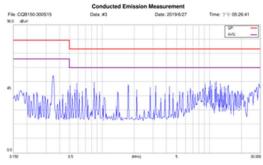




Neutral

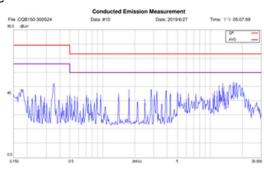


Neutral

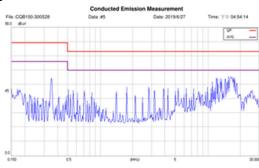




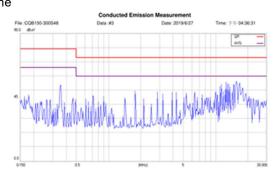
CQB150-300S24 Line

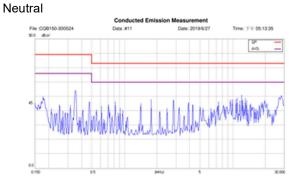


CQB150-300S28 Line

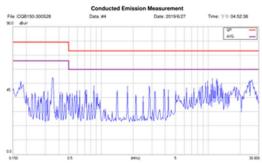


CQB150-300S48 Line

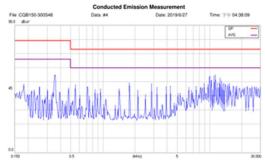




Neutral



Neutral



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